93L425A 1024 x 1-Bit Static Random Access Memory

General Description

The 93L425A is a 1024-bit read write Random Access Memory (RAM), organized 1024 words by one bit. It is designed for high speed cache control and buffer storage applications. The device includes full on-chip decoding, separate Data input and non-inverting Data output, as well as an active LOW Chip Select line.

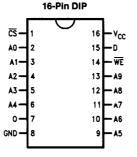
Features

- New design to replace old 93425/93L425
- Improved ESD thresholds
- Alpha hard without die coat
- Commercial address access time 93L425A

25 ns max

- Features TRI-STATE® output
- Power dissipation decreases with increasing temperature

Connection Diagram

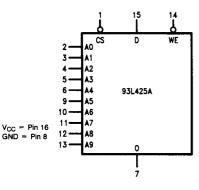


Top View

Order Number 93L425ADC or 93L425APC See NS Package Number J16A* or N16E*

Optional Processing QR = Burn-In *For most current package information, contact product marketing.

Logic Symbol



Pin Names

TL/D/10004-1

CS	Chip Select (Active LOW)			
A0-A9	Address Inputs			
WE	Write Enable Input (Active LOW)			
D	Data Input			
0	Data Output			

TL/D/10004-3

Absolute Maximum Ratings Above which the useful life may be impaired

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature

-65°C to +150°C

Supply Voltage Range

-0.5V to +7.0V

Input Voltage (DC) (Note 1)

-0.5V to V_{CC}

Input Current (DC)

-12 mA to +5.0 mA

Voltage Applied to Outputs (Note 2)

 $-0.5\mbox{V}$ to $5.5\mbox{V}$

Lead Temperature (Soldering, 10 sec.) Maximum Junction Temperature (T_J)

300°C +175°C

Output Current

+20 mA

Guaranteed Operating Ranges

Supply Voltage (V_{CC})

Commercial

5.0V ±5%

Case Temperature (T_C)

Commercial

0°C to +75°C

DC Characteristics over operating temperature ranges (Note 3)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _{OH}	Output HIGH Voltage	$V_{CC} = Min, I_{OH} = -5.2 \text{ mA}$	2.4			٧
VOL	Output LOW Voltage	V _{CC} = Min, I _{OL} = 16 mA			0.45	٧
V _{IH}	Input HIGH Voltage	Guaranteed Input HIGH Voltage for All Inputs (Notes 4, 5, & 6)				٧
V _{IL}	Input LOW Voltage	Guaranteed Input LOW Voltage for All Inputs (Notes 4, 5, & 6)			0.8	V
I _{IL}	Input LOW Current	V_{CC} = Max, V_{IN} = 0.4V		-180	-300	μΑ
I _{IH} Input HIGH Current		$V_{CC} = Max, V_{IN} = 4.5V$		1.0	40	μΑ
I _{IHB}	Input Breakdown Current	V _{CC} = Max, V _{IN} = V _{CC}			1.0	~mA
V _{IC}	Input Diode Clamp Voltage	$V_{CC} = Max, I_{IN} = -10 \text{ mA}$		-1.0	-1.5	٧
lozh	Output Current (HIGH Z)	V _{CC} = Max, V _{OUT} = 2.4V			50	μΑ
lozL		V _{CC} = Max, V _{OUT} = 0.5V			-50	μΑ
los	Output Current Short Circuit to Ground (Note 7)	V _{CC} = Max (Note 7)			-100	mA
Icc	Power Supply Current	V _{CC} = Max, All Inputs = GND, Output Open			65	mA

AC Electrical Characteristics (Note 6) V_{CC} = 5.0 ±5%, GND = 0V, T_C = 0°C to + 75°C

Symbol	Parameter	Conditions	Min	Max	Units
AD TIMING					
tACS	Chip Select Access Time	Figures		15	ns
t _{ZRCS}	Chip Select to HIGH Z	3a, 3b		15	ns
t _{AA}	Address Access Time (Note 8)			25	ns
RITE TIMING					
t _W	Write Pulse Width to Guarantee Writing (Note 9)		20		ns
twsp	Data Setup Time Prior to Write		5		ns
t _{WHD}	Data Hold Time after Write		5		ns
twsa	Address Setup Time Prior to Write (Note 9)	Figure 4	5		ns
t _{WHA}	Address Hold Time after Write		5		ns
twscs	Chip Select Setup Time Prior to Write		5		ns
twncs	Chip Select Hold Time after Write		5		ns
tzws	Write Enable to Output Disable		·	15	ns
twR	Write Recovery Time			15	ns

Note 1: Either input voltage limit or input current limit is sufficient to protect the inputs.

Note 2: Output current limit required.

Note 3: Typical values are at $V_{CC} = 5.0V$, $T_{C} = +25^{\circ}C$ and maximum loading.

Note 4: Static condition only.

Note 5: Functional testing done at input levels $V_{iH} = 0.45V$ (V_{OL} Max) and $V_{iH} = 2.4V$ (V_{OH} Min).

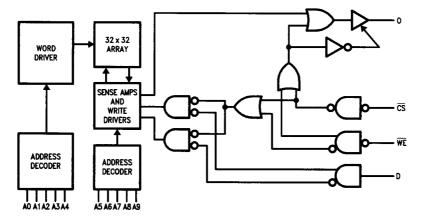
Note 6: AC testing done at input levels $V_{IH} = 3V$, $V_{IL} = 0V$.

Note 7: Short circuit to ground not to exceed one second.

Note 8: The maximum address access time is guaranteed to be the worst case bit in the memory using a pseudorandom testing pattern.

Note 9: t_W measured at $t_{WSA} = Min. \ t_{WSA}$ measured at $t_W = Min.$

Logic Diagram



TL/D/10004-2

Functional Description

The 93L425A is a fully decoded 1024-bit read write Random Access Memory organized 1024 words by one bit. Bit selection is achieved by means of a 10-bit address A0-A9.

One Chip Select (CS) input is provided for easy memory array expansion of up to 2048 bits without the need for external decoding. For larger memories the fast chip select access time permits direct address decoding without an increase in overall memory access time.

The read and write functions of the 93L425A are controlled by the state of the active LOW Write Enable \overline{WE} input. When \overline{WE} is held LOW and the chip is selected, the data at D is written into the location specified by the binary address present at A0 through A9. Since the write function is level triggered, data must be held stable at the data input for at least twsD(min) plus tw(min) plus twHD(min) to insure a valid write. When \overline{WE} is held HIGH and the chip selected, data is read from the addressed location and presented at the output O.

The 93L425A has a three-state output which provides an active pull-up or pull-down when enabled and a high impedance (HIGH Z) state when disabled. The active pull-up provides drive capability for high capacitive loads while the high impedance state allows optimization of word expansion in bus organized systems.

Truth Table

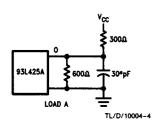
Inputs			Outputs	Mode	
cs	WE	Ð	0	Mode	
H	Н	Х	HIGH Z	Not Selected	
L	L	L '	HIGH Z	Write 0	
L	L	н	HIGH Z	Write 1	
٦	Н	X	D _{OUT}	Read	

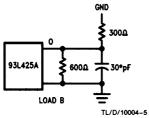
H = HiGH Voltage Level: 2.4V

L = LOW Voltage Level: 0.45V

X = Don't Care HIGH or LOW

HIGH Z = High-Impedance





Note: Load A is used for all production testing. *Includes jig and probe capacitance.

FIGURE 1. AC Test Output Load

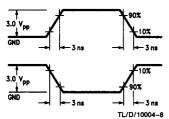
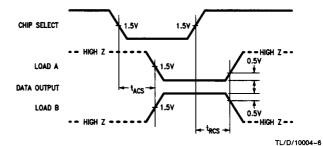
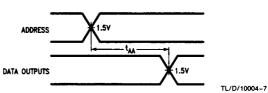


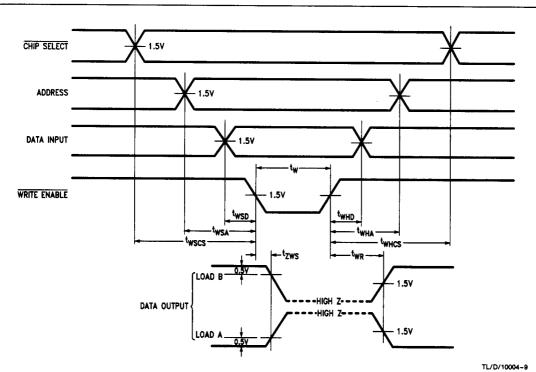
FIGURE 2. AC Test Input Levels



3a. Read Mode Propagation Delay from Chip Select



3b. Read Mode Propagation Delay from Address FIGURE 3. Read Mode Timing



Note 1: Timing Diagram represents one solution which results in an optimum cycle time Timing may be changed to fit various applications as long as the worst case limits are not violated.

Note 2: input voltage levels for worst case AC test are 3.0V-0V.

FIGURE 4. Write Mode Timing